

# P-Channel 100 V (D-S) MOSFET

## PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ ) Max. | $I_D$ (A) <sup>c</sup> | $Q_g$ (Typ.) |
|--------------|--------------------------------|------------------------|--------------|
| - 100        | 0.138 at $V_{GS} = - 10$ V     | - 16.3                 | 24 nC        |
|              | 0.141 at $V_{GS} = - 7.5$ V    | - 16.1                 |              |
|              | 0.142 at $V_{GS} = - 6$ V      | - 16.1                 |              |

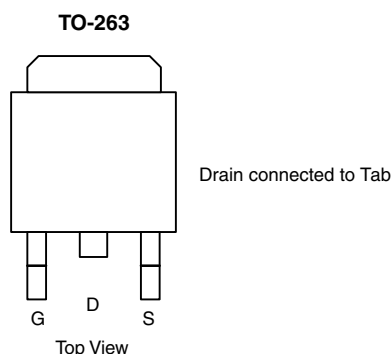
## FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $R_g$  and UIS Tested
- Material categorization:  
For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

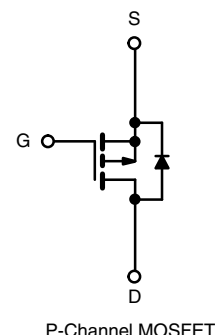

**RoHS**  
COMPLIANT

## APPLICATIONS

- DC/DC Converters
- Motor Control



**Ordering Information:**  
SUM25P10-138-E3 (Lead (Pb)-free)



## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

| Parameter                                        | Symbol         | Limit                   | Unit |
|--------------------------------------------------|----------------|-------------------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | - 100                   | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$                |      |
| Continuous Drain Current ( $T_J = 150$ °C)       | $T_C = 25$ °C  | $I_D$ - 16.7            | A    |
|                                                  | $T_C = 125$ °C | - 9.6                   |      |
| Pulsed Drain Current ( $t = 100$ $\mu$ s)        | $I_{DM}$       | - 40                    |      |
| Avalanche Current                                | $I_{AS}$       | - 25                    | mJ   |
| Single Pulse Avalanche Energy <sup>a</sup>       | $E_{AS}$       | 31.25                   |      |
| Power Dissipation                                | $T_C = 25$ °C  | $P_D$ 88.2 <sup>b</sup> | W    |
|                                                  | $T_A = 25$ °C  | 3.75                    |      |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | - 55 to 175             | °C   |

## THERMAL RESISTANCE RATINGS

| Parameter                    | Symbol     | Limit | Unit |
|------------------------------|------------|-------|------|
| Junction-to-Ambient Free Air | $R_{thJA}$ | 40    | °C/W |
| Junction-to-Case             | $R_{thJC}$ | 1.7   |      |

Notes:

a. Duty cycle  $\leq 1$  %.

b. See SOA curve for voltage derating.

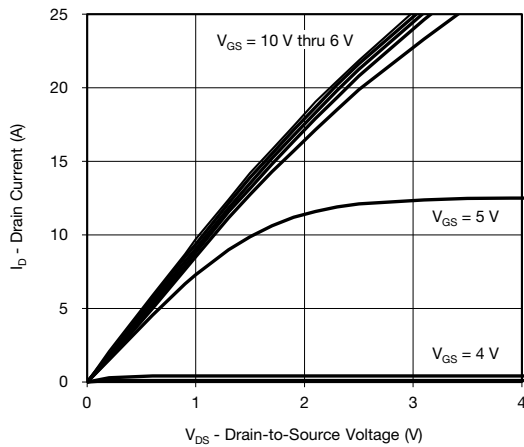
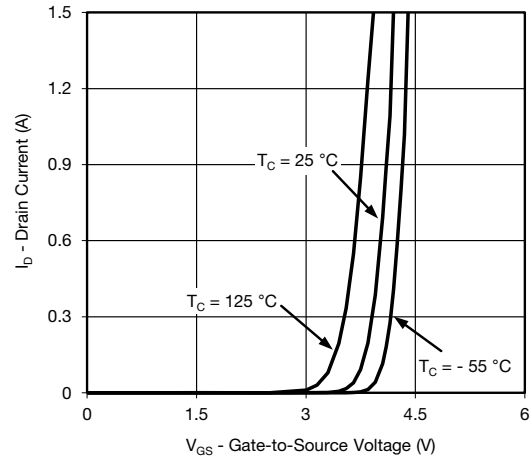
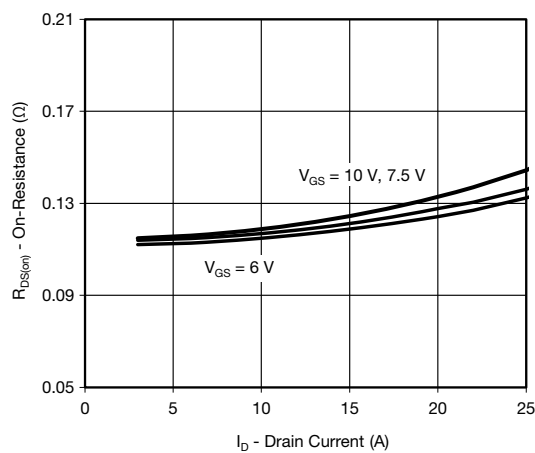
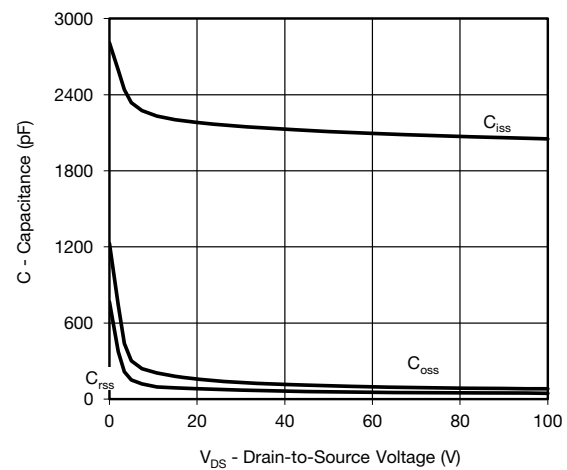
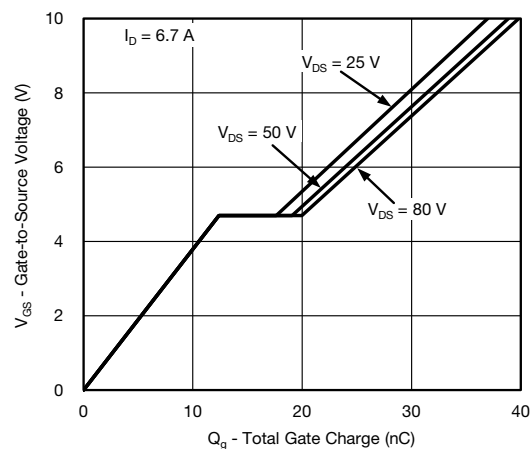
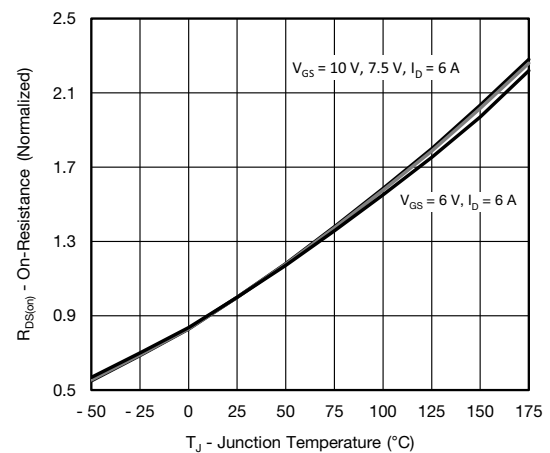
c.  $T_C = 25$  °C

| SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)                    |                                      |                                                                                                                             |       |        |        |       |
|------------------------------------------------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-------|--------|--------|-------|
| Parameter                                                                          | Symbol                               | Test Conditions                                                                                                             | Min.  | Typ.   | Max.   | Unit  |
| Static                                                                             |                                      |                                                                                                                             |       |        |        |       |
| Drain-Source Breakdown Voltage                                                     | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA                                                                            | - 100 |        |        | V     |
| Gate-Threshold Voltage                                                             | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA                                                               | - 2   |        | - 4    |       |
| V <sub>DS</sub> Temperature Coefficient                                            | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = - 250 μA                                                                                                   |       | - 105  |        | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient                                        | ΔV <sub>GS(th)</sub> /T <sub>J</sub> | I <sub>D</sub> = - 250 μA                                                                                                   |       | 6.6    |        |       |
| Gate-Body Leakage                                                                  | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                             |       |        | ± 100  | nA    |
| Zero Gate Voltage Drain Current                                                    | I <sub>DSS</sub>                     | V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V                                                                            |       |        | - 1    | μA    |
|                                                                                    |                                      | V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C                                                   |       |        | - 50   |       |
|                                                                                    |                                      | V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C                                                   |       |        | - 200  |       |
| On-State Drain Current <sup>a</sup>                                                | I <sub>D(on)</sub>                   | V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V                                                                           | - 20  |        |        | A     |
| Drain-Source On-State Resistance <sup>a</sup>                                      | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6 A                                                                            |       | 0.115  | 0.138  | Ω     |
|                                                                                    |                                      | V <sub>GS</sub> = - 7.5 V, I <sub>D</sub> = - 6 A                                                                           |       | 0.117  | 0.141  |       |
|                                                                                    |                                      | V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 6 A                                                                             |       | 0.118  | 0.142  |       |
| Forward Transconductance <sup>a</sup>                                              | g <sub>fs</sub>                      | V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 6 A                                                                            |       | 18     |        | S     |
| Dynamic <sup>b</sup>                                                               |                                      |                                                                                                                             |       |        |        |       |
| Input Capacitance                                                                  | C <sub>iss</sub>                     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 50 V, f = 1 MHz                                                                  |       | 2110   |        | pF    |
| Output Capacitance                                                                 | C <sub>oss</sub>                     |                                                                                                                             |       | 105    |        |       |
| Reverse Transfer Capacitance                                                       | C <sub>rss</sub>                     |                                                                                                                             |       | 58     |        |       |
| Total Gate Charge <sup>c</sup>                                                     | Q <sub>g</sub>                       | V <sub>DS</sub> = - 50 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6.7 A                                                |       | 40     | 60     | nC    |
|                                                                                    |                                      | V <sub>DS</sub> = - 50 V, V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 6.7 A                                                 |       | 24     | 36     |       |
| Gate-Source Charge <sup>c</sup>                                                    | Q <sub>gs</sub>                      |                                                                                                                             |       | 12.5   |        |       |
| Gate-Drain Charge <sup>c</sup>                                                     | Q <sub>gd</sub>                      |                                                                                                                             |       | 6.7    |        |       |
| Gate Resistance                                                                    | R <sub>g</sub>                       | f = 1 MHz                                                                                                                   | 2     | 8      | 16     | Ω     |
| Turn-On Delay Time <sup>c</sup>                                                    | t <sub>d(on)</sub>                   | V <sub>DD</sub> = - 50 V, R <sub>L</sub> = 10 Ω<br>I <sub>D</sub> ≅ - 5 A, V <sub>GEN</sub> = - 10 V, R <sub>g</sub> = 1 Ω  |       | 7      | 14     | ns    |
| Rise Time <sup>c</sup>                                                             | t <sub>r</sub>                       |                                                                                                                             |       | 12     | 20     |       |
| Turn-Off Delay Time <sup>c</sup>                                                   | t <sub>d(off)</sub>                  |                                                                                                                             |       | 46     | 70     |       |
| Fall Time <sup>c</sup>                                                             | t <sub>f</sub>                       |                                                                                                                             |       | 40     | 60     |       |
| Turn-On Delay Time <sup>c</sup>                                                    | t <sub>d(on)</sub>                   | V <sub>DD</sub> = - 50 V, R <sub>L</sub> = 10 Ω<br>I <sub>D</sub> ≅ - 5 A, V <sub>GEN</sub> = - 4.5 V, R <sub>g</sub> = 1 Ω |       | 12     | 20     |       |
| Rise Time <sup>c</sup>                                                             | t <sub>r</sub>                       |                                                                                                                             |       | 105    | 160    |       |
| Turn-Off Delay Time <sup>c</sup>                                                   | t <sub>d(off)</sub>                  |                                                                                                                             |       | 36     | 54     |       |
| Fall Time <sup>c</sup>                                                             | t <sub>f</sub>                       |                                                                                                                             |       | 34     | 51     |       |
| Source-Drain Diode Ratings and Characteristics T <sub>C</sub> = 25 °C <sup>b</sup> |                                      |                                                                                                                             |       |        |        |       |
| Continuous Current                                                                 | I <sub>S</sub>                       |                                                                                                                             |       |        | - 16.3 | A     |
| Pulsed Current (t = 100 μs)                                                        | I <sub>SM</sub>                      |                                                                                                                             |       |        | - 40   |       |
| Forward Voltage <sup>a</sup>                                                       | V <sub>SD</sub>                      | I <sub>F</sub> = - 5 A, V <sub>GS</sub> = 0 V                                                                               |       | - 0.85 | - 1.5  | V     |
| Reverse Recovery Time                                                              | t <sub>rr</sub>                      | I <sub>F</sub> = - 5 A, dI/dt = 100 A/μs                                                                                    |       | 70     | 105    | ns    |
| Peak Reverse Recovery Current                                                      | I <sub>RM(REC)</sub>                 |                                                                                                                             |       | - 7    | - 14   | A     |
| Reverse Recovery Charge                                                            | Q <sub>rr</sub>                      |                                                                                                                             |       | 220    | 330    | nC    |

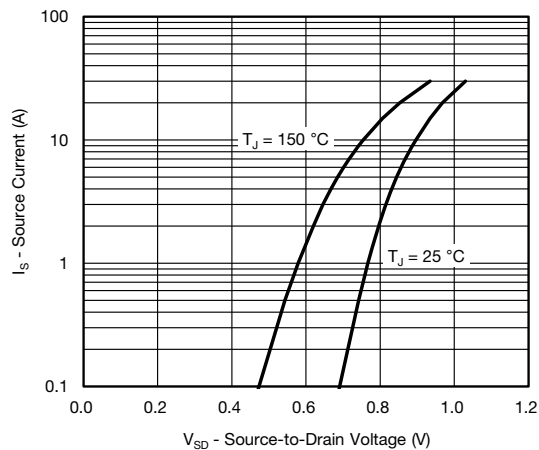
## Notes:

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.  
c. Independent of operating temperature.

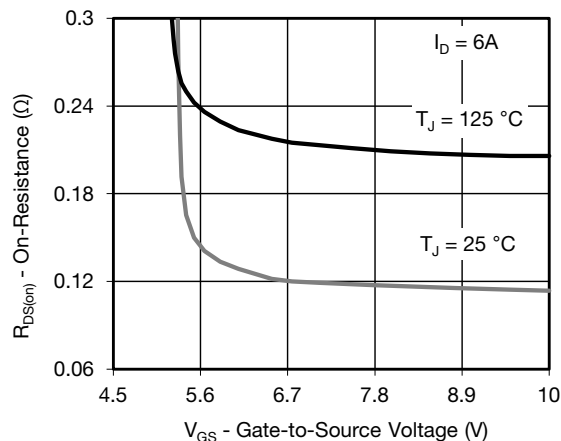
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current and Gate Voltage**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**

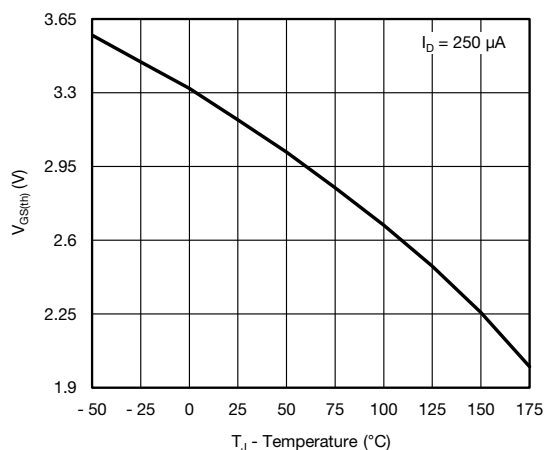
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



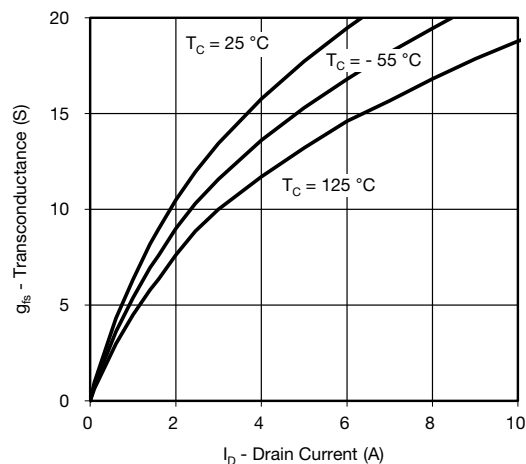
Source-Drain Diode Forward Voltage



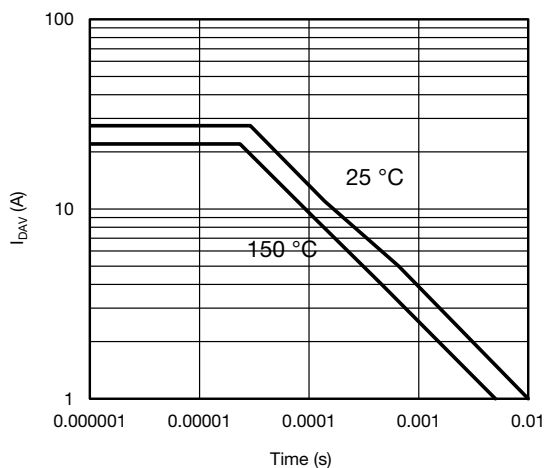
On-Resistance vs. Gate-to-Source Voltage



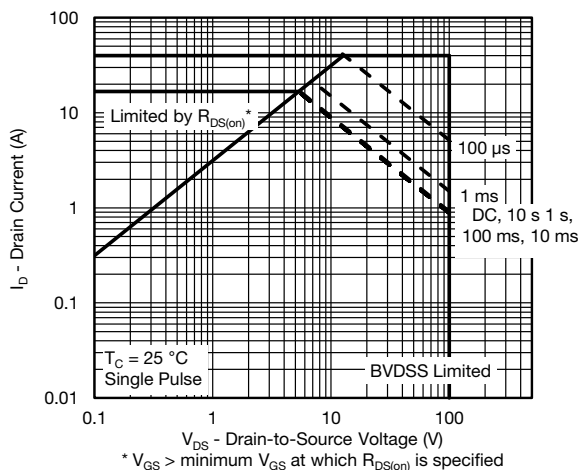
Threshold Voltage



Transconductance

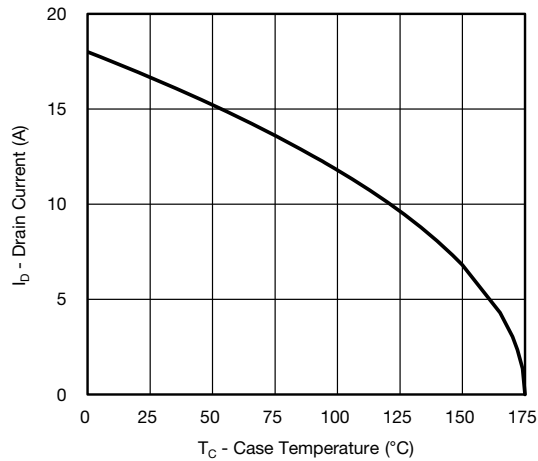


Single Pulse Avalanche Capability

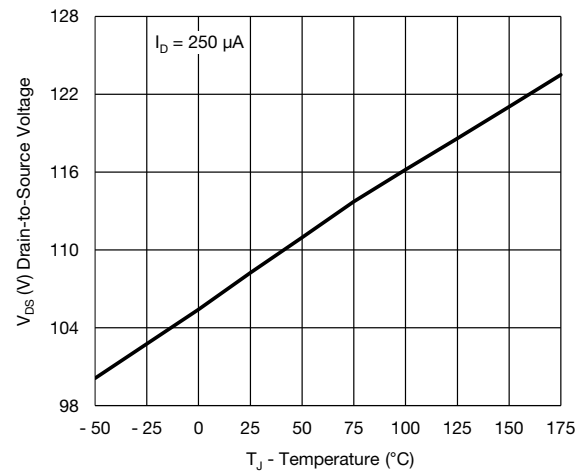


Safe Operating Area, Junction-to-Case

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

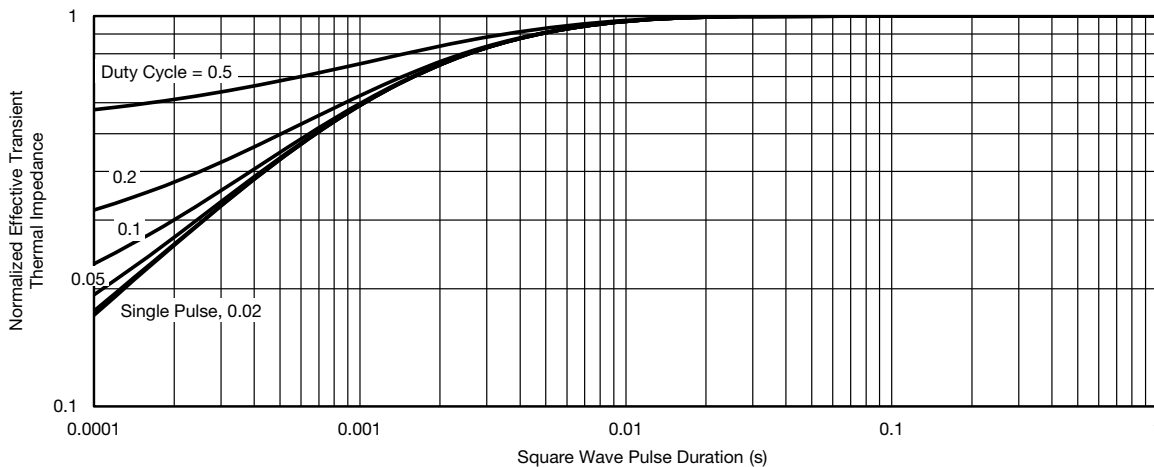


Current Derating\*



Drain Source Breakdown vs. Junction Temperature

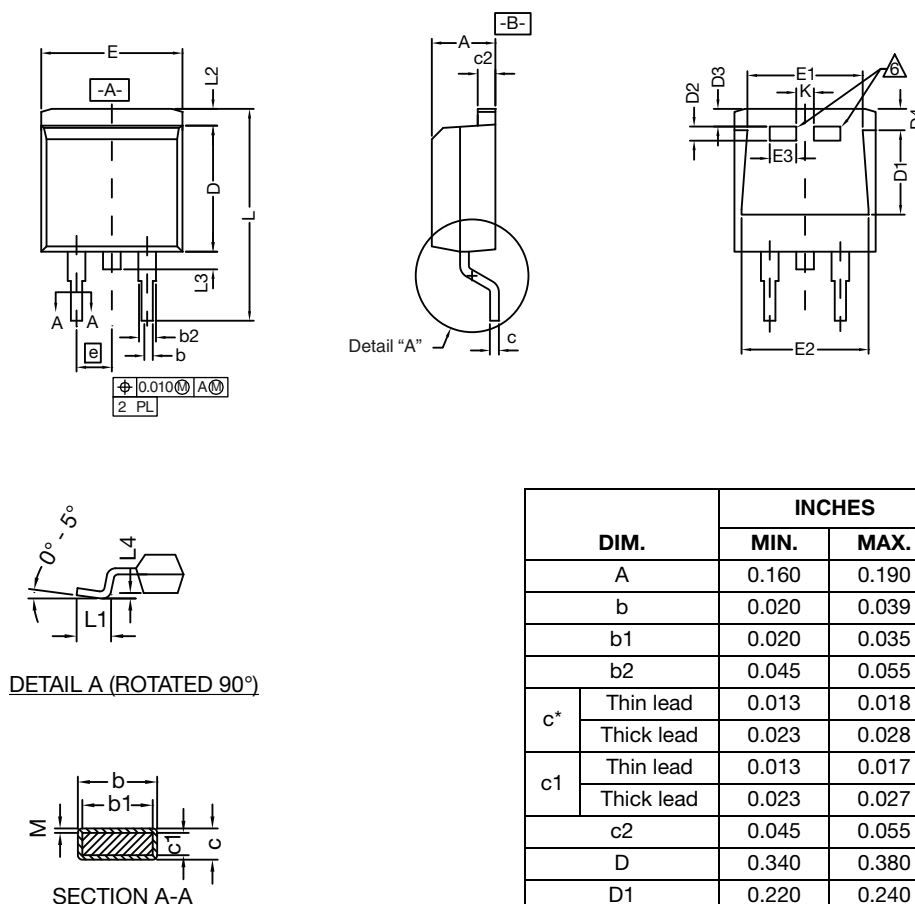
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150\text{ °C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case

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## TO-263 (D<sup>2</sup>PAK): 3-LEAD



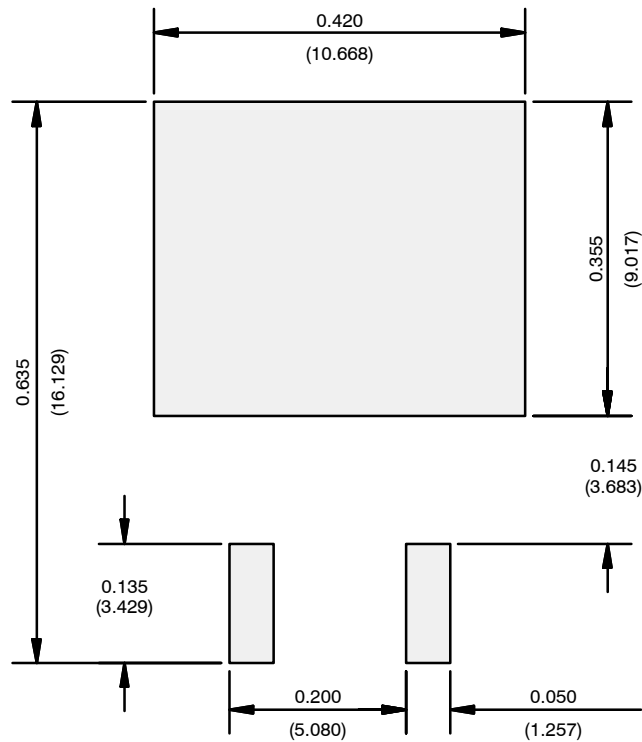
| DIM. |            | INCHES    |       | MILLIMETERS |        |
|------|------------|-----------|-------|-------------|--------|
|      |            | MIN.      | MAX.  | MIN.        | MAX.   |
| A    |            | 0.160     | 0.190 | 4.064       | 4.826  |
| b    |            | 0.020     | 0.039 | 0.508       | 0.990  |
| b1   |            | 0.020     | 0.035 | 0.508       | 0.889  |
| b2   |            | 0.045     | 0.055 | 1.143       | 1.397  |
| c*   | Thin lead  | 0.013     | 0.018 | 0.330       | 0.457  |
|      | Thick lead | 0.023     | 0.028 | 0.584       | 0.711  |
| c1   | Thin lead  | 0.013     | 0.017 | 0.330       | 0.431  |
|      | Thick lead | 0.023     | 0.027 | 0.584       | 0.685  |
| c2   |            | 0.045     | 0.055 | 1.143       | 1.397  |
| D    |            | 0.340     | 0.380 | 8.636       | 9.652  |
| D1   |            | 0.220     | 0.240 | 5.588       | 6.096  |
| D2   |            | 0.038     | 0.042 | 0.965       | 1.067  |
| D3   |            | 0.045     | 0.055 | 1.143       | 1.397  |
| D4   |            | 0.044     | 0.052 | 1.118       | 1.321  |
| E    |            | 0.380     | 0.410 | 9.652       | 10.414 |
| E1   |            | 0.245     | -     | 6.223       | -      |
| E2   |            | 0.355     | 0.375 | 9.017       | 9.525  |
| E3   |            | 0.072     | 0.078 | 1.829       | 1.981  |
| e    |            | 0.100 BSC |       | 2.54 BSC    |        |
| K    |            | 0.045     | 0.055 | 1.143       | 1.397  |
| L    |            | 0.575     | 0.625 | 14.605      | 15.875 |
| L1   |            | 0.090     | 0.110 | 2.286       | 2.794  |
| L2   |            | 0.040     | 0.055 | 1.016       | 1.397  |
| L3   |            | 0.050     | 0.070 | 1.270       | 1.778  |
| L4   |            | 0.010 BSC |       | 0.254 BSC   |        |
| M    |            | -         | 0.002 | -           | 0.050  |

ECN: T13-0707-Rev. K, 30-Sep-13  
DWG: 5843

### Notes

- Plane B includes maximum features of heat sink tab and plastic.
- No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- Pin-to-pin coplanarity max. 4 mils.
- \*: Thin lead is for SUB, SYB.  
Thick lead is for SUM, SYM, SQM.
- Use inches as the primary measurement.
- This feature is for thick lead.

**RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads  
 Dimensions in Inches/(mm)

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